INTEGRATED CIRCUITS

DATA SHEET



PCF8531 34 × 128 pixel matrix driver

Product specification Supersedes data of 1999 Mar 22 File under Integrated Circuits, IC12 1999 Aug 10





$34\times128\ pixel\ matrix\ driver$

PCF8531

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1 FEATURES

- Single-chip LCD controller/driver
- 34 row and 128 column outputs
- Display data RAM 34 × 128 bits
- 128 icons (last row is used for icons)
- Fast mode I²C-bus interface (400 kbit/s)
- Software selectable multiplex rates: 1:17, 1:26 and 1:34
- Icon mode with Mux rate 1:2:
 - Featuring reduced current consumption while displaying icons only.
- · On-chip:
 - Generation of V_{LCD} (external supply also possible)
 - Selectable linear temperature compensation
 - Oscillator requires no external components (external clock also possible)
 - Generation of intermediate LCD bias voltages
 - Power-on reset.
- · No external components required
- Software selectable bias configuration
- Logic supply voltage range V_{DD1} to V_{SS1} 1.8 to 5.5 V
- Supply voltage range for on-chip voltage generator V_{DD2} and V_{DD3} to V_{SS1} and V_{SS2} 2.5 to 4.5 V
- Display supply voltage range V_{LCD} to V_{SS}:
 - Normal mode 4 to 9 V
 - Icon mode 3 to 9 V.
- Low power consumption, suitable for battery operated systems
- CMOS compatible inputs
- · Manufactured in silicon gate CMOS process.

2 APPLICATIONS

- · Telecommunication systems
- · Automotive information systems
- · Point-of-sale terminals
- Instrumentation.

3 GENERAL DESCRIPTION

The PCF8531 is a low power CMOS LCD row/column driver, designed to drive dot matrix graphic displays at multiplex rates of 1 : 17, 1 : 26 and 1 : 34. Furthermore, it can drive up to 128 icons. All necessary functions for the display are provided in a single chip, including on-chip generation of V_{LCD} and the LCD bias voltages, resulting in a minimum of external components and low power consumption. The PCF8531 is compatible with most microcontrollers and communicates via a two-line bidirectional bus (I²C-bus). All inputs are CMOS compatible.

Remark: Icon mode is used to save current. When only icons are displayed, a much lower operating voltage (V_{LCD}) can be used and the switching frequency of the LCD outputs is reduced. In most applications it is possible to use V_{DD} as V_{LCD} .

4 PACKAGES

The PCF8531 is available as chip with bumps in tray.

5 ORDERING INFORMATION

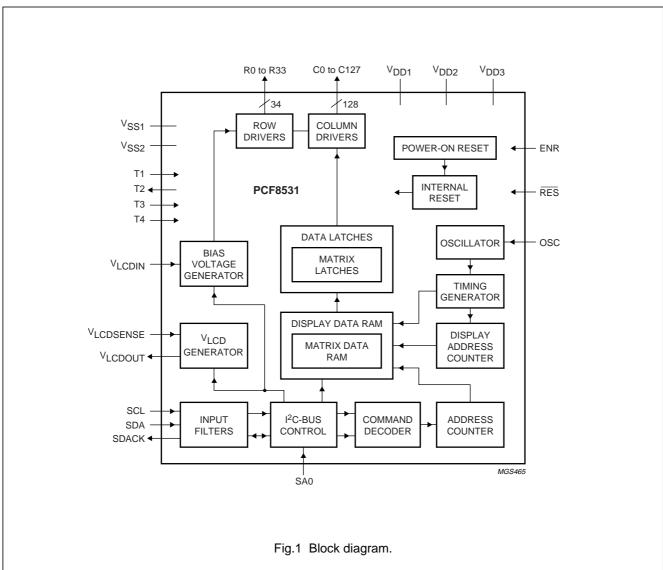
TYPE	PACKAGE					
NUMBER	NAME	DESCRIPTION	VERSION			
PCF8531U	_	chip with bumps in tray	_			



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6 BLOCK DIAGRAM



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7 PINNING

SYMBOL	PAD	DESCRIPTION		
	1 to 14	dummy pad		
OSC	15	oscillator input; note 1		
V _{LCDSENSE}	16	voltage multiplier regulation input (V _{LCD}); note 2		
V _{LCDOUT}	17 to 23	voltage multiplier output (V _{LCD}); note 3		
V _{LCDIN}	24 to 30	LCD supply voltage (V _{LCD}); note 2		
RES	31	external reset input (active LOW); note 4		
V_{DD3}	32 to 34	supply voltage 3; note 5		
V _{DD2}	35 to 42	supply voltage 2; note 5		
V _{DD1}	43 to 49	supply voltage 1; note 5		
SDA	50 and 51	serial data line input of the I ² C-bus		
SDACK	52	serial data acknowledge output; note 6		
	53	dummy pad		
SA0	54	I ² C-bus slave address input; bit 0		
ENR	55	enable internal Power-on reset input; note 7		
T4	56	test 4 input; note 8		
V _{SS2}	57 to 63	ground 2; note 9		
V _{SS1}	64 to 70	ground 1; note 9		
T3	71	test 3 input; note 8		
T1	72	test 1 input; note 8		
SCL	73 and 74	serial clock line input of the I ² C-bus		
	75 to 77	dummy pad		
T2	78	test 2 output; note 10		
	79 to 86	dummy pad		
R0	87	LCD row driver output		
R2	88	LCD row driver output		
R4	89	LCD row driver output		
R6	90	LCD row driver output		
R8	91	LCD row driver output		
R10	92	LCD row driver output		
R12	93	LCD row driver output		
R14	94	LCD row driver output		
R16	95	LCD row driver output		
R18	96	LCD row driver output		
R20	97	LCD row driver output		
R22	98	LCD row driver output		
R24	99	LCD row driver output		
R26	100	LCD row driver output		
R28	101	LCD row driver output		
R30	102	LCD row driver output		
R32	103	LCD row driver output		

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SYMBOL	PAD	DESCRIPTION
C0 to C127	104 to 231	LCD column driver outputs
R33	232	LCD row driver output; icon row
R31	233	LCD row driver output
R29	234	LCD row driver output
R27	235	LCD row driver output
R25	236	LCD row driver output
R23	237	LCD row driver output
R21	238	LCD row driver output
R19	239	LCD row driver output
R17	240	LCD row driver output
R15	241	LCD row driver output
R13	242	LCD row driver output
R11	243	LCD row driver output
R9	244	LCD row driver output
R7	245	LCD row driver output
R5	246	LCD row driver output
R3	247	LCD row driver output
R1	248	LCD row driver output

Notes

- 1. If the on-chip oscillator is used this input must be connected to V_{DD1} .
- 2. If the internal V_{LCD} generation is used, V_{LCDOUT} , V_{LCDIN} and $V_{LCDSENSE}$ must be connected together.
- 3. If in the application an external V_{LCD} is used, then the V_{LCDOUT} pin must be left open-circuit, otherwise the chip will be damaged.
- 4. If only the internal Power-on reset is used this input must be connected to V_{DD1}.
- 5. V_{DD1} is for the logic supply, V_{DD2}, and V_{DD3} are for the voltage multiplier. For split power supplies V_{DD2} and V_{DD3} must be connected together. If only one supply voltage is available V_{DD1}, V_{DD2} and V_{DD3} must be connected together.
- 6. Serial data acknowledge for the I²C-bus. By connecting SDACK to SDA externally, the SDA line becomes fully I²C-bus compatible. Having the acknowledge output separated from the serial data line is advantageous in Chip-On-Glass (COG) applications. In COG applications where the track resistance from the SDACK pad to the system SDA line can be significant, a potential divider is generated by the bus pull-up resistor and the Indium Tin Oxide (ITO) track resistance. It is possible that during the acknowledge cycle the PCF8531 will not be able to create a valid logic 0 level. By splitting the SDA input from the SDACK output the device could be used in a mode that ignores the acknowledge bit. In COG applications where the acknowledge cycle is required, it is necessary to minimize the track resistance from the SDACK pad to the system SDA line to guarantee a valid LOW level.
- 7. If ENR is connected to V_{SS} Power-on reset is disabled; to enable Power-on reset ENR should be connected to V_{DD1}.
- 8. In the application this input must be connected to V_{SS} .
- 9. V_{SS1} and V_{SS2} must be connected together.
- 10. In the application T2 must be left open-circuit.

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8 FUNCTIONAL DESCRIPTION

8.1 Oscillator

The on-chip oscillator provides the clock signal for the display system. No external components are required and the OSC input must be connected to V_{DD} . An external clock signal, if used, is connected to this input.

8.2 Power-on reset

The on-chip Power-on reset initializes the chip after Power-on or power failure.

8.3 I2C-bus controller

The I²C-bus controller receives and executes the commands. The PCF8531 acts as an I²C-bus slave receiver and therefore cannot control bus communication.

8.4 Input filters

To enhance noise immunity in electrically adverse environments, RC low-pass filters are provided on the SDA and SCL lines.

8.5 Display data RAM

The PCF8531 contains a 34×128 bits static RAM, which stores the display data. The RAM is divided into 6 banks of 128 bytes ($6 \times 8 \times 128$ bits). Bank 6 is used for icon data. During RAM access, data is transferred to the RAM via the I²C-bus interface. There is a direct correspondence between the X address and column output number.

8.6 Timing generator

The timing generator produces the various signals required to drive the internal circuitry. Internal chip operation is not disturbed by operations on the data buses.

8.7 Address counter

The address counter sets the addresses of the display data RAM for writing.

8.8 Display address counter

The display address counter generates the addresses for read out of the display data.

8.9 Command decoder

The command decoder identifies command words that arrive on the I²C-bus and determines the destination for the following data bytes.

8.10 Bias voltage generator

The bias voltage generator generates 4 buffered intermediate bias voltages. This block contains the generator for the reference voltages and the 4 buffers. This block can operate in two voltage ranges:

Normal mode; 4.0 to 9.0 V

• Power save mode; 3.0 to 9.0 V.

8.11 V_{LCD} generator

The V_{LCD} voltage generator contains a configurable 2 to 5 times voltage multiplier; this is software programmable.

8.12 Reset

The PCF8531 has the possibility of two reset modes, internal Power-on reset or external reset (RES). The reset mode is selected using the ENR signal. After a reset the chip has the following state:

- All row and column outputs are set to V_{SS} (display off)
- · RAM data is undefined
- · Power-down mode.

8.13 Power-down

During power-down all static currents are switched off (no internal oscillator, no timing and no LCD segment drive system), and all LCD outputs are internally connected to V_{SS} . The I²C-bus function remains operational.

8.14 Column driver outputs

The LCD drive section includes 128 column outputs (C0 to C127) which should be connected directly to the LCD. The column output signals are generated in accordance with the multiplexed row signals and with the data in the display latch. When less than 128 columns are required the unused column outputs should be left open-circuit.

8.15 Row driver outputs

The LCD drive section includes 34 row outputs (R0 to R33) which should be connected directly to the LCD. The row output signals are generated in accordance with the selected LCD drive mode. If less than 34 rows or lower Mux rates are required the unused outputs must be left open-circuit. The row signals are interlaced i.e. the selection order is R0, R2, ..., R1, R3 etc.

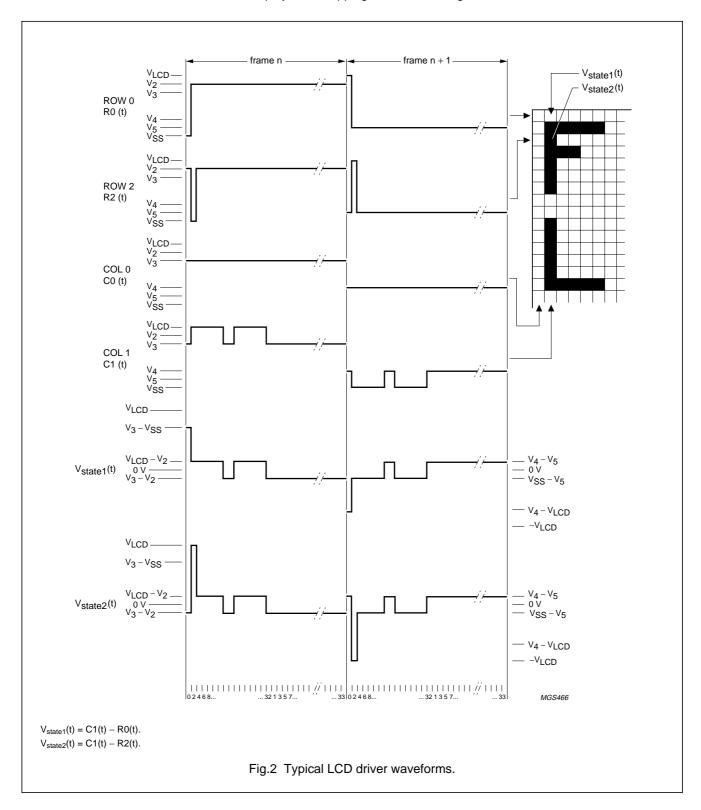
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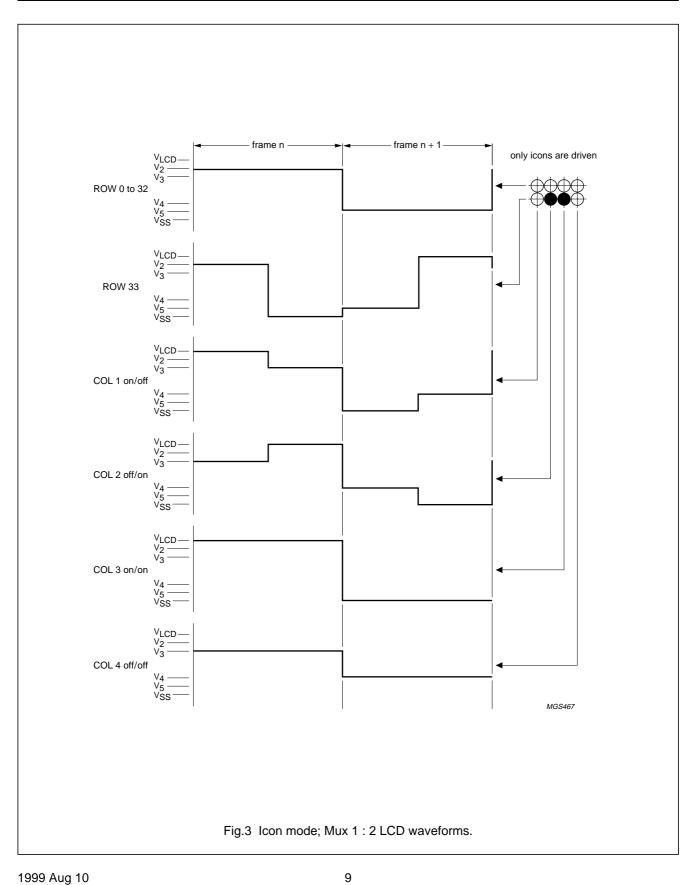
8.16 LCD waveforms and DDRAM to data mapping

The LCD waveforms and the DDRAM to display data mapping are shown in Figs 2, 3 and 4.



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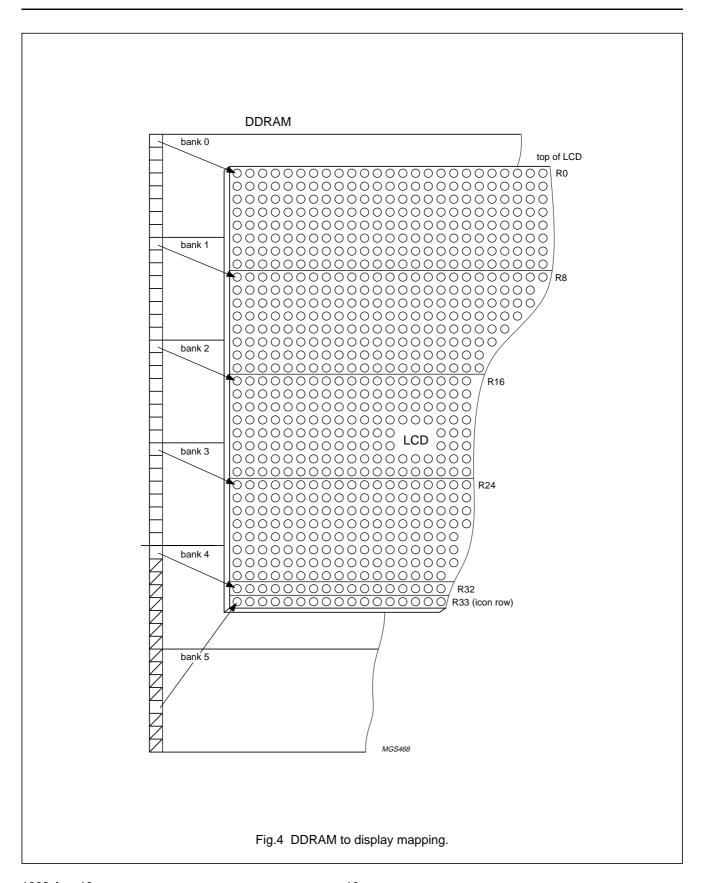
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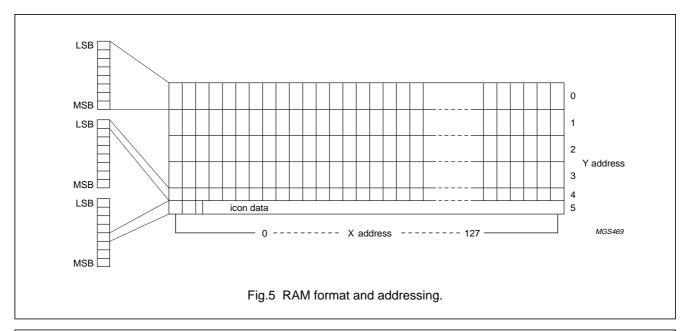


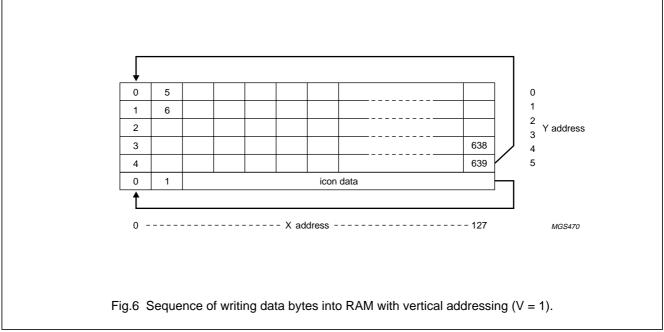
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8.17 Addressing

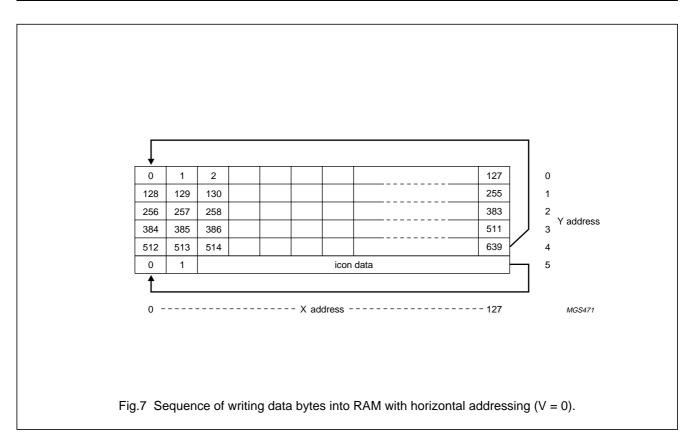
Data is written in bytes into the RAM matrix of the PCF8531 as illustrated in Figs 5, 6 and 7. The display RAM has a matrix of 34×128 bits. The columns are addressed by the address pointer. The address ranges are X 0 to X 127 (7FH) and Y 0 to Y 5 (5H). Addresses outside of these ranges are not allowed. In vertical addressing mode (V = 1) the Y address increments after each byte (see Fig.6). After the last Y address (Y = 4) Y wraps around to 0 and X increments to address the next column. In horizontal addressing mode (V = 0) the X address increments after each byte (see Fig.7). After the last X address (X = 127) X wraps around to 0 and Y increments to address the next row. After the very last address (X = 127 and Y = 4) the address pointers wrap around to address (X = 0 and Y = 0). It should be noted that in bank 4 only the LSB (DB0) of the data will be written into the RAM. The Y address 5 is reserved for icon data and is not affected by the addressing mode; it should be noted that in bank 5 only the 5th data bit (DB4) will be written into the RAM.





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8.18 Instructions

Only two PCF8531 registers, the Instruction Register (IR) and the Data Register (DR) can be directly controlled by the MPU. Before internal operation, control information is stored temporarily in these registers to allow interfacing to various types of MPUs which operate at different speeds or to allow interfacing to peripheral control ICs.

The PCF8531 operation is controlled by the instructions given in Table 1. Details are explained in subsequent sections.

Instructions are of 4 types, those that:

- Define PCF8531 functions such as display configuration, etc.
- 2. Set internal RAM addresses
- 3. Perform data transfer with internal RAM
- 4. Others.

In normal use, category 3 instructions are used most frequently. Automatic incrementing by 1 of internal RAM addresses after each data write reduces the MPU program load.

8.18.1 RESET

After reset or internal Power-on reset (depending on application), the LCD driver will be set into the following state:

- Power-down mode (PD = 1)
- Horizontal addressing (V = 0)
- Display blank (D = 0; E = 0), no icon mode (IM = 0)
- Address counter X[6:0] = 0; Y[2:0] = 0
- Bias system BS[2:0] = 0
- Multiplex rate M[1:0] = 0 (Mux rate 1 : 17)
- Temperature control mode TC[2:0] = 0
- HV-gen control, HVE = 0 the HV generator is switched off, PRS = 0 and S[1:0] = 0
- V_{LCD} = 0 V
- · RAM data is undefined
- Command page definition H[1:0] = 0.

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8.18.2 FUNCTION SET

8.18.2.1 PD

When PD = 1, the Power-down mode of the LCD driver is active:

- All LCD outputs at V_{SS} (display off)
- Power-on reset detection active, oscillator off
- V_{LCD} can be disconnected
- I²C-bus is operational, commands can be executed
- RAM contents not cleared; RAM data can be written
- · Register settings remain unchanged.

8.18.2.2 V

When V=0 the horizontal addressing is selected. The data is written into the DDRAM as shown in Fig.7. When V=1 the vertical addressing is selected. The data is written into the DDRAM as shown in Fig.6. Icon data is written independently of V when Y address is 5.

8.18.3 SET Y ADDRESS

 Y_2 , Y_1 and Y_0 defines the Y address vector of the display RAM.

Table 1 Yaddress

Y ₂	Y ₁	Y ₀	BANK
0	0	0	0
0	0	1	1
0	1	0	2
0	1	1	3
1	0	0	4
1	0	1	5 (icons)

 Table 2
 Programming the required bias system

BS[2]	BS[1]	BS[0]	n	BIAS SYSTEM	COMMENT
0	0	0	7	1/11	
0	0	1	6	1/10	
0	1	0	5	1/9	
0	1	1	4	1/8	
1	0	0	3	1/7	recommended for 1 : 34
1	0	1	2	1/6	recommended for 1 : 26
1	1	0	1	1/5	recommended for 1 : 17
1	1	1	0	1/4	recommended for icon mode

8.18.4 SET X ADDRESS

The X address points to the columns. The range of X is 0 to 127 (7FH).

8.18.5 SET MULTIPLEX RATE

M[1:0] selects the multiplex rate (see Table 8).

8.18.6 DISPLAY CONTROL (D, E AND IM)

Bits D and E select the display mode (see Table 6). Bit IM sets the display to icon mode.

8.18.7 SET BIAS SYSTEM

Different multiplex rates require different bias settings. These are programmed by BS[2:0], which sets the binary number n. The optimum value for n is given by

$$n = \sqrt{Mux rate} - 3$$

Supported values of n are given in Table 2. Table 3 shows the intermediate bias voltages.

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8.18.8 LCD BIAS VOLTAGE

Table 3 Intermediate LCD bias voltages

SYMBOL	BIAS VOLTAGES	EXAMPLE FOR 1/7 BIAS
V1	V _{LCD}	V _{LCD}
V2	$\frac{n+3}{n+4} \times V_{LCD}$	⁶ ∕ ₇ × V _{LCD}
V3	$\frac{n+2}{n+4} \times V_{LCD}$	5∕ ₇ × V _{LCD}
V4	$\frac{2}{n+4} \times V_{LCD}$	$^{2}\!/_{7} \times V_{LCD}$
V5	$\frac{1}{n+4} \times V_{LCD}$	¹⁄ ₇ × V _{LCD}
V6	V _{SS}	V _{SS}

8.18.9 SET V_{OP} VALUE:

The operating voltage V_{LCD} can be set by software. The voltage at reference temperature [V_{LCD} (T = T_{cut})] can be calculated as: V_{LCD} (T_{cut}) = (a + $V_{OP} \times$ b).

The generated voltage is dependent on the temperature, programmed Temperature Coefficient (TC) and the programmed voltage at reference temperature (T_{cut}). $V_{LCD} = V_{LCD} (T_{cut}) \times [1 + TC \times (T - T_{cut})]$.

The parameter values are given in Table 4. Two overlapping V_{LCD} ranges are selectable via the command 'HV-gen control' (see Table 4 and Fig.8). The maximum voltage that can be generated is dependent on the V_{DD2} and V_{DD3} voltage and the display load current. For Mux 1:34 the optimum operating voltage of the liquid can be calculated as:

$$V_{LCD} = \frac{1 + \sqrt{34}}{\sqrt{2 \times \left(1 - \frac{1}{\sqrt{34}}\right)}} \times V_{th} = 5.30 \times V_{th}$$

Where V_{th} is the threshold voltage of the liquid crystal material used.

The practical value for V_{OP} is determined by equating $V_{off(rms)}$ with defined LCD threshold voltage (V_{th}), typically when the LCD exhibits approximately 10% contrast.

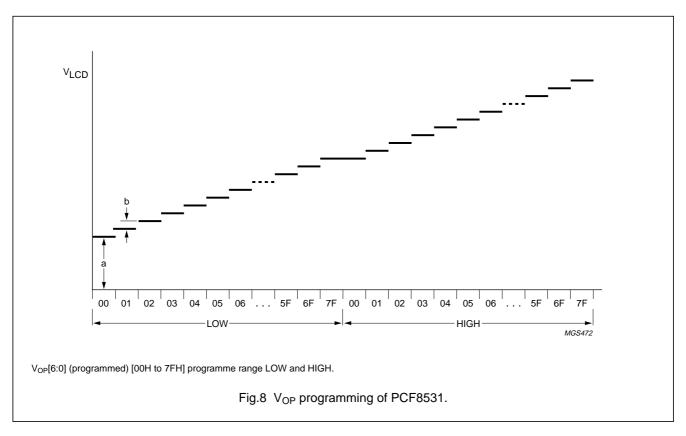
As the programming range for the internally generated V_{LCD} allows values above the maximum allowed V_{LCD} , the user has to ensure while setting the V_{OP} register and selecting the temperature compensation, that under all conditions and including all tolerances the V_{LCD} limit of maximum 9 V will never be exceeded.

Table 4 Parameter values for the HV generator programming

SYMBOL	VAL	_UE	UNIT	
STMBOL	PRS = 0 PRS = 1		ONT	
T _{cut}	27	27	°C	
а	2.94	6.75	V	
b	0.03	0.03	V	
Programming range	2.94 to 6.75	6.75 to 10.56	V	

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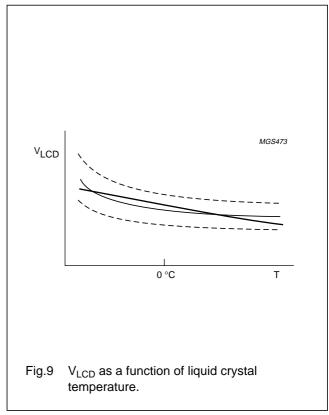
8.18.10 VOLTAGE MULTIPLIER CONTROL S[1:0]

The PCF8531 incorporates a software configurable voltage multiplier. After reset (internal or external) the voltage multiplier is set to $2 \times V_{DD2}$. The voltage multiplier factors are set via the command 'HV-gen configuration' (see Tables 4, 5 and 6).

8.18.11 TEMPERATURE COMPENSATION

Due to the temperature dependency of the liquid crystal's viscosity the LCD controlling voltage V_{LCD} should usually be increased at lower temperatures to maintain optimum contrast. Figure 9 shows V_{LCD} for high multiplex rates.

Linear temperature compensation is supported in the PCF8531. The temperature coefficient of V_{LCD} can be selected from 8 values by setting bits TC[2:0] (see Tables 4, 5 and 6).



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Table 5 Instruction set

INSTRUCTION	I ² C-BUS COMMAND ⁽¹⁾		I ² C-BUS COMMAND BYTE						DESCRIPTION		
	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	
H ₁ and H ₀ = dor	i't care (H indep	endent	comm	and pag	ge)			!		
NOP	0	0	0	0	0	0	0	0	0	0	no operation
Write data	1	0	D ₇	D ₆	D ₅	D ₄	D ₃	D ₂	D ₁	D ₀	write data to display RAM
Set default H[1:0]	0	0	0	0	0	0	0	0	0	1	select H[1:0] = 0
H ₁ = 0 and H ₀ =	0 (funct	ion and	RAM c	omman	d page)			•	•	
Instruction set	0	0	0	0	0	0	1	0	H1	H0	select command page
Function set	0	0	0	0	1	0	0	PD	V	0	power-down control; entry mode
Set Yaddress of RAM	0	0	0	1	0	0	0	Y ₂	Y ₁	Y ₀	set Y address of RAM; $0 \le Y \le 5$
Set X address of RAM	0	0	1	X ₆	X ₅	X ₄	X ₃	X ₂	X ₁	X ₀	set X address part of RAM; $0 \le X \le 127$
H ₁ = 0 and H ₀ =	1 (displ	ay settir	ig com	mand p	age)	•					
Multiplex rate	0	0	0	0	0	0	0	1	M1	M0	select multiplex rate
Display control	0	0	0	0	0	0	1	D	IM	Е	set display configuration
Bias system	0	0	0	0	0	1	0	BS ₂	BS ₁	BS ₀	set Bias System (BSx)
H ₁ = 1 and H ₀ =	0 (HV-ge	en comr	nand pa	age)	•	•		•	•		
HV-gen control	0	0	0	0	0	0	0	1	PRS	HVE	set V _{LCD} programming range
HV-gen configuration	0	0	0	0	0	0	1	0	S1	S0	set voltage multiplication factor
Temperature control	0	0	0	0	1	0	0	TC ₂	TC ₁	TC ₀	set temperature coefficient
Test modes	0	0	0	1	Х	Х	Х	Х	Х	Х	do not use (reserved for test)
V _{LCD} control	0	0	1	V _{OP6}	V _{OP5}	V _{OP4}	V _{OP3}	V _{OP2}	V _{OP1}	V _{OP0}	$\begin{array}{c} \text{set V}_{LCD} \text{ register} \\ 0 \leq V_{OP} \leq 127 \end{array}$

Note

1. R/\overline{W} is set in the slave address byte; Co and RS are set in the control byte.

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 Table 6
 Explanations for symbols in Table 5

BIT	0	1
PD	chip is active	chip is in Power-down mode
V	horizontal addressing	vertical addressing
IM	normal mode; full display + icons	icon mode; only icons are displayed
H[1:0] ⁽¹⁾	see Table 7	
D and E	see Table 7	
HVE	voltage multiplier disabled	voltage multiplier enabled
PRS	V _{LCD} programming range LOW	V _{LCD} programming range HIGH
TC[2:0]	see Table 7	
S[1:0]	see Table 7	

Note

1. The H-bits identify the command page (use set default H[1:0] command to set H[1:0] = 0.

Table 7 Description of bits H, D and E, TC and S

BITS	VALUE	DESCRIPTION				
Command page (H)						
H[1:0]	00	function and RAM command page				
	01	display setting command page				
	10	HV-gen command page				
Display mo	des (D, E)					
D and E	00	display blank				
	10	normal mode				
	01	all display segments				
	11	inverse video mode				
Temperatu	re coefficien	et (TC)				
TC[2:0]	000	temperature coefficient 0				
	001	temperature coefficient 1				
	010	temperature coefficient 2				
	011	temperature coefficient 3				
	100	temperature coefficient 4				
	101	temperature coefficient 5				
	110	temperature coefficient 6				
	111	temperature coefficient 7				
Voltage mu	Itiplier facto	or (S)				
S[1:0]	00	2 × voltage multiplier				
	01	3 × voltage multiplier				
	10	4 × voltage multiplier				
	11	5 × voltage multiplier				

Table 8 Multiplex rates

MUX RATE	M1	МО
1 : 17	0	0
1 : 26	1	0
1 : 34	0	1

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9 I2C-BUS INTERFACE

9.1 Characteristics of the I²C-bus

The I²C-bus is for bi-directional, two-line communication between different ICs or modules. The two lines are a Serial Data line (SDA) and a Serial Clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor. Data transfer may be initiated only when the bus is not busy.

9.1.1 BIT TRANSFER

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as a control signal (see Fig.10).

9.1.2 START AND STOP CONDITIONS

Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line, while the clock is HIGH is defined as the START condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the STOP condition (P). The START and STOP conditions are illustrated in Fig.11.

9.1.3 SYSTEM CONFIGURATION

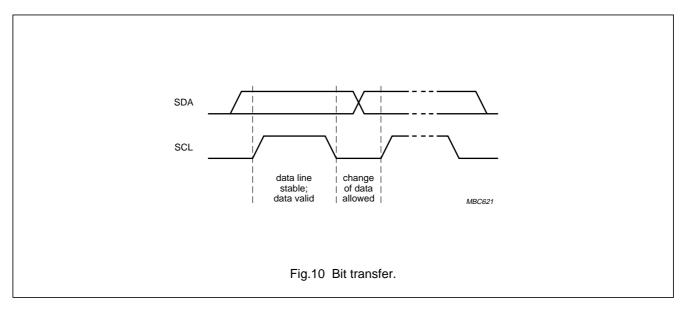
The system configuration is illustrated in Fig.12

- Transmitter: the device which sends the data to the bus
- Receiver: the device which receives the data from the bus

- Master: the device which initiates a transfer, generates clock signals and terminates a transfer
- · Slave: the device addressed by a master
- Multi-Master: more than one master can attempt to control the bus at the same time without corrupting the message
- Arbitration: procedure to ensure that, if more than one master simultaneously tries to control the bus, only one is allowed to do so and the message is not corrupted
- Synchronization: procedure to synchronize the clock signals of two or more devices.

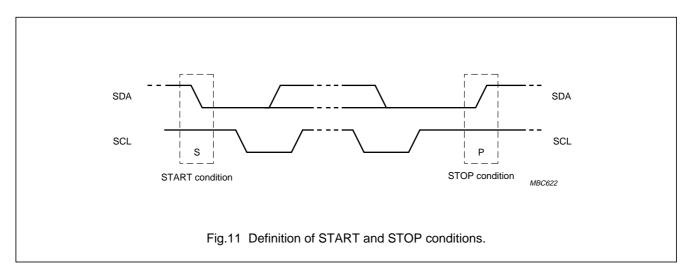
9.1.4 ACKNOWLEDGE

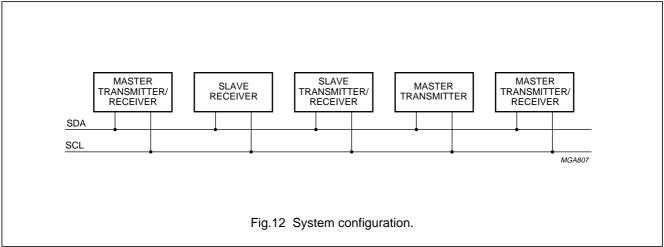
Acknowledge on the I²C-bus is illustrated in Fig.13. Each byte of eight bits is followed by an acknowledge bit. The acknowledge bit is a HIGH signal put on the bus by the transmitter during which time the master generates an extra acknowledge related clock pulse. A slave receiver which is addressed must generate an acknowledge after the reception of each byte. Also a master receiver must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter. The device that acknowledges must pull-down the SDA line during the acknowledge clock pulse so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse (set-up and hold times must be taken into consideration). A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event the transmitter must leave the data line HIGH to enable the master to generate a STOP condition.

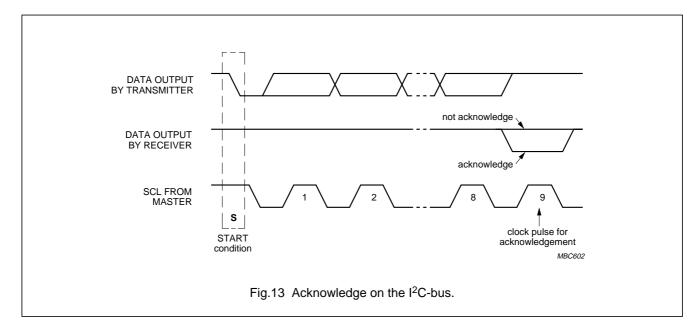


34×128 pixel matrix driver

PCF8531







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9.2 I²C-bus protocol

This driver does not support 'read'. The PCF8531 is a slave receiver. Therefore, it only responds when $R/\overline{W} = 0$ in the slave address byte.

Before any data is transmitted on the I^2C -bus, the device which should respond is addressed first. Two 7-bit slave addresses (0111100 and 0111101) are reserved for the PCF8531. The least significant bit of the slave address is set by connecting the input SA0 to either logic 0 (V_{SS}) or logic 1 (V_{DD}).

The I²C-bus protocol is illustrated in Fig.14.

The sequence is initiated with a START condition (S) from the I²C-bus master which is followed by the slave address. All slaves with the corresponding address acknowledge in parallel, all the others will ignore the I²C-bus transfer. After acknowledgement, one or more command words follow which define the status of the addressed slaves. A command word consists of a control byte, which defines Co and RS, plus a data byte (see Fig.14 and Table 1).

The last control byte is tagged with a cleared most significant bit, the continuation bit Co. The control and data bytes are also acknowledged by all addressed slaves on the bus.

After the last control byte, depending on the RS bit setting, either a series of display data bytes or command data bytes may follow. If the RS bit was set to logic 1, these display bytes are stored in the display RAM at the address specified by the data pointer.

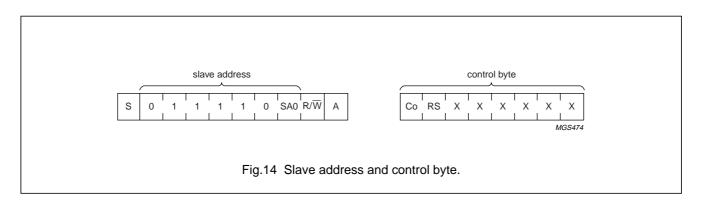
The data pointer is automatically updated and the data is directed to the intended PCF8531 device. If the RS bit of the last control byte was set to logic 0, these command bytes will be decoded and the setting of the device will be changed according to the received commands.

The acknowledgement after each byte is made only by the addressed PCF8531. At the end of the transmission the I^2C -bus master issues a STOP condition (P).

9.3 Command decoder

- Pairs of bytes; information in 2nd byte, first byte determines whether information is display or instruction data
- Stream of information bytes after Co = 0; display or instruction data depending on last RS (Register Selection).

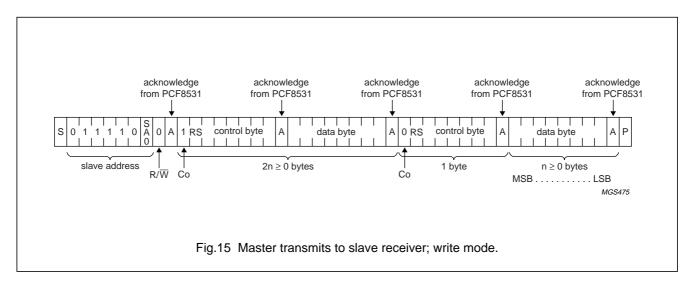
The command decoder identifies command words that arrive on the I²C-bus. The most significant bit of a control byte is the continuation bit Co. If this bit is logic 1, it indicates that only one data byte, either command or RAM data, will follow. If this bit is logic 0, it indicates that a series of data bytes, either command or RAM data, may follow. The DB6 bit of a control byte is the RAM data/command bit RS. When this bit is at logic 1, it indicates that another RAM data byte will be transferred next. If the bit is at logic 0, it indicates that another command byte will be transferred next.



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10 LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134); note 1.

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V _{DD1}	logic supply voltage	-0.5	+5.5	V
V_{DD2}, V_{DD3}	multiplier supply voltage	-0.5	+4.5	V
I _{DD}	supply current	-50	+50	mA
V_{LCD}	LCD supply voltage	-0.5	+9.0	V
I _{LCD}	LCD supply current	-50	+50	mA
I _{SS}	negative supply current	-50	+50	mA
V _I /V _O	input/output voltage (any input/output)	-0.5	V _{DD} + 0.5	V
I _I	DC input current	-10	+10	mA
Io	DC output current	-10	+10	mA
P _{tot}	total power dissipation per package	-	300	mW
P/out	power dissipation per output	_	30	mW
T _{stg}	storage temperature	-65	+150	°C
Tj	junction temperature	_	150	°C

Note

 Parameters are valid over the operating temperature range unless otherwise specified. All voltages referenced to V_{SS} unless otherwise noted.

11 HANDLING

Inputs and outputs are protected against electrostatic discharge in normal handling. However, to be totally safe, it is recommended to take normal precautions appropriate to handling MOS devices (see "Handling MOS Devices").

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12 DC CHARACTERISTICS

 $V_{DD1} = 1.8 \ (1.9) \ to \ 5.5 \ V; \ V_{DD2} \ and \ V_{DD3} = 2.5 \ to \ 4.5 \ V; \ V_{SS1,2} = 0 \ V; \ V_{DD1} \ to \ V_{DD3} \leq V_{LCD} \leq 9.0 \ V; \ T_{amb} = -40 \ to \ +85 \ ^{\circ}C; \ unless \ otherwise \ specified.$

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supplies			'	!		
V _{LCD}	LCD supply voltage	note 1	4.0	_	9.0	V
		icon mode; note 1	3.0	_	9.0	V
V _{DD1}	logic supply voltage		1.9	_	5.5	V
		T _{amb} ≥ -25 °C	1.8	_	5.5	V
$V_{DD2,}V_{DD3}$	multiplier supply voltage	LCD voltage internally generated	2.5	_	4.5	V
I _{DD}	supply current	Power-down mode; internal V _{LCD}	_	2	10	μΑ
		normal mode; internal V _{LCD} ; notes 2 and 3	_	170	350	μΑ
		normal mode; external V _{LCD} ; note 2	_	10	50	μΑ
I _{LCD}	LCD input current	normal mode; external V _{LCD} ; notes 2 and 4	_	25	100	μΑ
		icon mode; external V _{LCD} ; notes 2 and 5	-	15	70	μΑ
V _{POR}	Power-on reset level	note 6	0.9	1.2	1.6	V
Logic		•		•	•	•
V _{IL}	LOW-level input voltage		V _{SS}	_	0.3V _{DD}	V
V _{IH}	HIGH-level input voltage		0.7V _{DD}	_	V _{DD}	V
I _{OL}	LOW-level output current (SDA)	V _{OL} = 0.4 V; V _{DD} = 5 V	3.0	_	_	mA
ILI	input leakage current	$V_I = V_{DD}$ or V_{SS}	-1	_	+1	μΑ
Column an	d row outputs	•		•		
R _{o(col)}	column output resistance C0 to C127	note 7	_	12	20	kΩ
R _{o(row)}	row output resistance R0 to R33	note 7	_	12	20	kΩ
V _{bias(col)}	bias tolerance C0 to C127		-100	0	+100	mV
V _{bias(row)}	bias tolerance R0 to R33		-100	0	+100	mV

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SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT					
V _{LCD} generation											
V _{LCD(tol)}	LCD voltage tolerance, internal V _{LCD}	TC1 to TC7; note 8	-	_	±3.9	%					
TC0	LCD voltage temperature coefficient 0	$T_{amb} = -20 \text{ to } +70 ^{\circ}\text{C}$	_	0	-	%/°C					
TC1	LCD voltage temperature coefficient 1	$T_{amb} = -20 \text{ to } +70 ^{\circ}\text{C}$	_	-0.026	_	%/°C					
TC2	LCD voltage temperature coefficient 2	$T_{amb} = -20 \text{ to } +70 ^{\circ}\text{C}$	_	-0.039	_	%/°C					
TC3	LCD voltage temperature coefficient 3	$T_{amb} = -20 \text{ to } +70 ^{\circ}\text{C}$	_	-0.052	_	%/°C					
TC4	LCD voltage temperature coefficient 4	$T_{amb} = -20 \text{ to } +70 ^{\circ}\text{C}$	_	-0.078	_	%/°C					
TC5	LCD voltage temperature coefficient 5	$T_{amb} = -20 \text{ to } +70 ^{\circ}\text{C}$	-	-0.13	_	%/°C					
TC6	LCD voltage temperature coefficient 6	$T_{amb} = -20 \text{ to } +70 ^{\circ}\text{C}$	-	-0.19	_	%/°C					
TC7	LCD voltage temperature coefficient 7	$T_{amb} = -20 \text{ to } +70 ^{\circ}\text{C}$	-	-0.26	_	%/°C					
T _{cut}	cut point temperature		_	27	_	°C					

Notes

- As the programming range for the internally generated V_{LCD} allows values above the maximum allowed V_{LCD}, the
 user has to ensure while setting the V_{OP} register and selecting the temperature compensation, that under all
 conditions and including all tolerances the V_{LCD} limit of maximum 9 V will never be exceeded.
- 2. LCD outputs are open-circuit, inputs at V_{DD} or V_{SS} ; bus inactive.
- 3. V_{DD1} to V_{DD3} = 2.85 V; V_{LCD} = 7.0 V; voltage multiplier = 3 × V_{DD} ; f_{OSC} = 34 kHz.
- 4. V_{DD1} to $V_{DD3} = 2.75 \text{ V}$; $V_{LCD} = 9.0 \text{ V}$; $f_{OSC} = 34 \text{ kHz}$.
- 5. V_{DD1} to $V_{DD3} = 2.75 \text{ V}$; $V_{LCD} = 3.5 \text{ V}$; $f_{OSC} = 34 \text{ kHz}$.
- 6. Resets all logic when $V_{DD1} < V_{POR}$.
- 7. $|I_{LOAD}| \le 50 \mu A$; outputs tested one at a time.
- 8. $V_{LCD} \le 7.7 \text{ V}.$

34 × 128 pixel matrix driver

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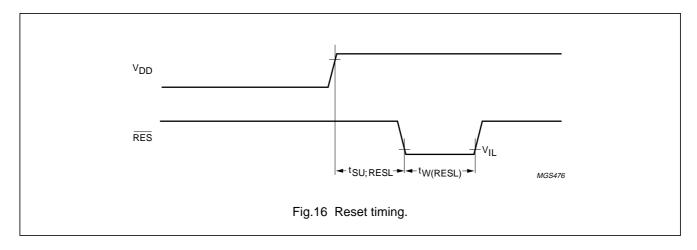
13 AC CHARACTERISTICS

 V_{DD1} = 1.8 to 5.5 V; V_{DD2} and V_{DD3} = 2.5 to 4.5 V; V_{SS1} and V_{SS2} = 0 V; V_{DD1} to $V_{DD3} \le V_{LCD} \le 9.0$ V; V_{amb} = -40 to +85 °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
f _{frame}	LCD frame frequency (internal clock)	$V_{DD} = 3.0 \text{ V; note 1}$	40	66	135	Hz
fosc	oscillator frequency (not available at any pin)		20	34	65	kHz
f _{clk(ext)}	external clock frequency		20	_	65	kHz
t _{W(RESL)}	reset LOW pulse width	note 2	300	_	_	ns
t _{SU;RESL}	reset LOW pulse set-up time after Power-on		_	_	30	μs
Serial-bus	interface; note 3					
f _{SCL}	SCL clock frequency		0	-	400	kHz
t _{SCLL}	SCL clock LOW period		1.3	_	_	μs
t _{SCLH}	SCL clock HIGH period		0.6	_	_	μs
t _{SU;DAT}	data set-up time		100	_	_	ns
t _{HD;DAT}	data hold time		0	_	0.9	μs
t _r	SCL, SDA rise time	note 4	20 + 0.1C _b	_	300	ns
t _f	SCL, SDA fall time	note 4	20 + 0.1C _b	_	300	ns
C _b	capacitive load represented by each bus line		_	_	400	pF
t _{SU;STA}	set-up time for a repeated START condition		0.6	_	_	μs
t _{HD;STA}	start condition hold time		0.6	_	_	μs
t _{SU;STO}	set-up time for STOP condition		0.6	_	_	μs
t _{SW}	tolerable spike width on bus		_	_	50	ns
t _{BUF}	bus free time between a STOP and START condition		1.3	_	_	μs

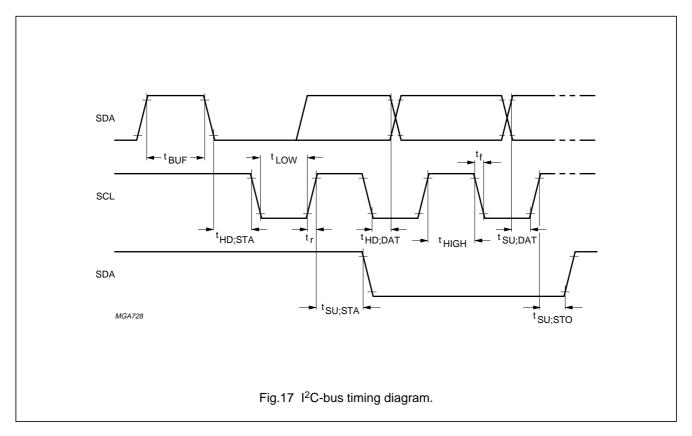
Notes

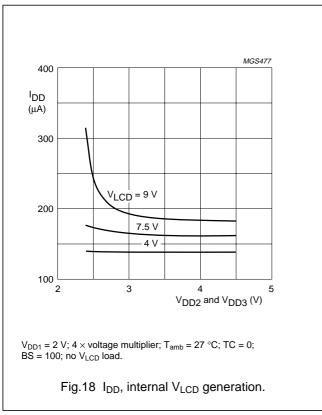
- 1. $f_{frame} = f_{clk(ext)}/480$; $f_{OSC}/480$.
- 2. For $t_{W(RESL)} > 3$ ns a reset may be generated.
- 3. All timing values are valid within the operating supply voltage and ambient temperature range and are referenced to V_{IL} and V_{IH} with an input voltage swing of V_{SS} to V_{DD} .
- 4. $C_b = total$ capacitance of one bus line in pF.

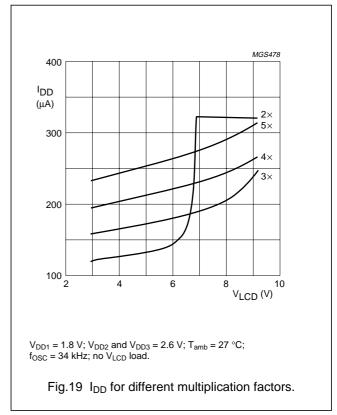


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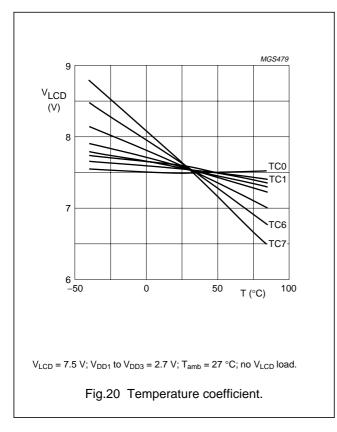


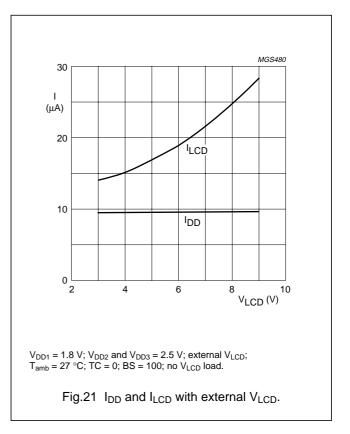


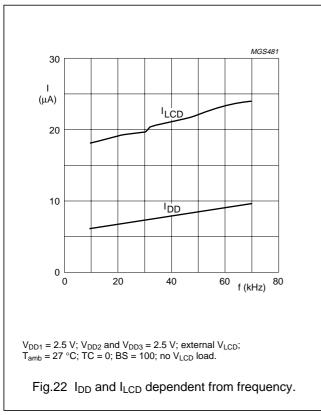


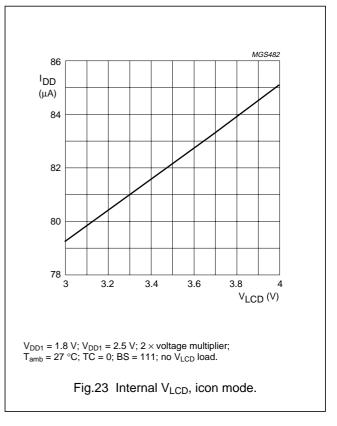
34×128 pixel matrix driver

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14 APPLICATION INFORMATION

Table 9 Programming example for PCF8531

Table 9	Programming example for PCP0551							-		_
STEP			SE	RIAL E	SUS BY	TE			DISPLAY	OPERATION
SIEF	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	DISPLAT	OPERATION
1	0	1	1	1	1	0	SA0	0		start; slave address; R/W = 0
2	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
3	0	0	0	0	0	0	0	1		H[1:0] independent command; select function and RAM command page (H[1:0] = 00)
4	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
5	0	0	1	0	0	0	1	0		function and RAM command page PD = 0 and V = 1
6	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
7	0	0	0	0	1	0	0	1		function and RAM command page select display setting command page H[1:0] = 01
8	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
9	0	0	0	0	1	1	0	0		display setting command page; set normal mode (D = 1; IM = 0 and E = 0)
10	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
11	0	0	0	0	0	1	0	1		select Mux rate 1 : 34
12	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
13	0	0	0	0	0	0	0	1		H[2:0] independent command; select function and RAM command page H[1:0] = 00
14	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
15	0	0	0	0	1	0	1	0		function and RAM command page; select HV-gen command page H[1:0] = 10
16	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
17	0	0	0	0	1	0	1	1		HV-gen command page; select voltage multiplication factor 5 S[1:0] = 11
18	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
19	0	0	1	0	0	0	1	0		HV-gen command page; select temperature coefficient 2 TC[2:0] = 010
20	0	0	0	0	0	1	1	0		HV-gen command page; select high V _{LCD} programming range (PRS = 1); voltage multiplier off (HVE = 0)

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0755	SERIAL BUS BYTE					TE			DIODI AV	open ation
STEP	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	DISPLAY	OPERATION
21	1	0	0	0	0	0	0	0		control byte; Co = 1; RS = 0
22	1	0	1	0	0	0	0	0		HV-gen command page; set V _{LCD} = 7.71 V; V _{OP} [6:0] = 0100000
23	0	1	0	0	0	0	0	0		control byte; Co = 0; RS = 1
24	0	0	0	1	1	1	1	1	MGS405	data write; Y and X are initialized to 0 by default, so they are not set here
25	0	0	0	0	0	1	0	1	MGS406	data write
26	0	0	0	0	0	1	1	1	MGS407	data write
27	0	0	0	0	0	0	0	0	MGS407	data write
28	0	0	0	1	1	1	1	1	MGS409	data write
29	0	0	0	0	0	1	0	0	MGS410	data write
30	0	0	0	1	1	1	1	1	MGS411	data write; last data and stop transmission

34×128 pixel matrix driver

PCF8531

0755			SE	RIAL E	SUS BY	TE			DIODI AV	open ation
STEP	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	DISPLAY	OPERATION
31	0	1	1	1	1	0	SA0	0	MGS411	repeated start; slave address; R/W = 0
32	1	0	0	0	0	0	0	0	MGS411	control byte; Co = 1; RS = 0
33	0	0	0	0	0	0	0	1	MGS411	H[1:0] independent command; select function and RAM command page H[1:0] = 00
34	1	0	0	0	0	0	0	0	MGS411	control byte; Co = 1; RS = 0
35	0	0	0	0	1	0	0	1	MGS411	function and RAM command page; select display setting command page H[1:0] = 01
36	1	0	0	0	0	0	0	0	MGS411	control byte; Co = 1; RS = 0
37	0	0	0	0	0	0	0	1	MGS411	H[1:0] independent command; select function and RAM command page H[1:0] = 00
38	1	0	0	0	0	0	0	0	MGS411	control byte; Co = 1; RS = 0

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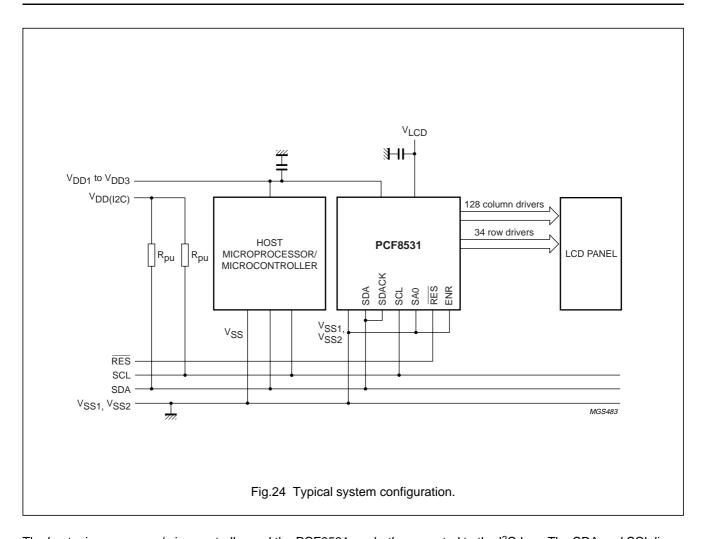
PCF8531

STEP			SE	RIAL E	US BY	TE			DISPLAY	ODEDATION
SIEP	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	DISPLAT	OPERATION
39	0	0	0	0	1	1	0	1	MGS412	display control; set inverse video mode (D = 1; E = 1 and IM = 0)
40	1	0	0	0	0	0	0	0	MGS412	control byte; Co = 1; RS = 0
41	1	0	0	0	0	0	0	0	MGS412	set X address of RAM; set address to '0000000'
42	0	1	0	0	0	0	0	0	MGS412	control byte; Co = 0; RS = 1
43	0	0	0	0	0	0	0	0	MGS414	data write

The pinning of the PCF8531 is optimized for single plane wiring e.g. for chip-on-glass display modules. Display size: 34×128 pixels.

34 × 128 pixel matrix driver

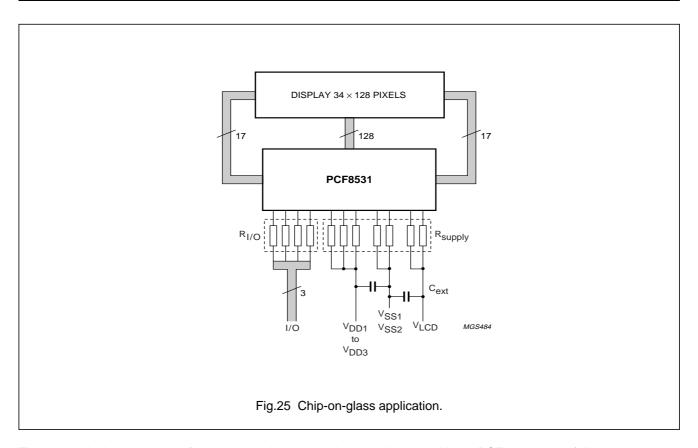
PCF8531



The host microprocessor/microcontroller and the PCF8531 are both connected to the I^2C -bus. The SDA and SCL lines must be connected to the positive power supply via pull-up resistors. The internal oscillator requires no external components. The appropriate intermediate biasing voltage for the multiplexed LCD waveforms are generated on-chip. The only other connections required to complete the system are to the power supplies (V_{DD} , V_{SS} and V_{LCD}) and suitable capacitors for decoupling V_{LCD} and V_{DD} .

34 × 128 pixel matrix driver

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The required minimum values for the external capacitors in an application with the PCF8531 are as follows:

- C_{ext} = 100 nF for V_{LCD} and V_{SS1} and V_{SS2} , and C_{ext} = 470 nF for V_{DD1} to V_{DD3} and V_{SS1} and V_{SS2}
- Higher capacitor values are recommended for ripple reduction
- For COG applications the recommended ITO track resistance is to be minimized for the I/O and supply connections. Optimized values for these tracks are below 50 Ω for the supply (R_{supply}) and below 100 Ω for the I/O connections (R_{I/O}).
- To reduce the sensitivity of the reset to ESD/EMC disturbances for a chip-on-glass application, it is strongly
 recommended to implement on the glass (ITO) a series input resistance in the reset line (recommended minimum
 value 8 kΩ). If the reset input is not used, it should be connected to V_{DD1} using a short connection.

$34\times128\ \text{pixel}$ matrix driver

PCF8531

15 BONDING PAD LOCATIONS

Table 10 Bonding pad location

All x and y coordinates are referenced to the centre of the chip (dimensions in μm ; see Fig.28).

SYMBOL	PAD	х	у
dummy	1	+5973.6	-821.7
dummy	2	+5969.5	+823.4
dummy	3	+5899.5	+823.4
dummy	4	+5829.5	+823.4
dummy	5	+5479.5	+823.4
dummy	6	+5409.5	+823.4
dummy	7	+5059.5	+823.4
dummy	8	+4989.5	+823.4
dummy	9	+4639.5	+823.4
dummy	10	+4569.5	+823.4
dummy	11	+4219.5	+823.4
dummy	12	+4149.5	+823.4
dummy	13	+3799.5	+823.4
dummy	14	+3729.5	+823.4
OSC	15	+3449.5	+823.4
V _{LCDSENSE}	16	+3169.5	+823.4
V _{LCDOUT}	17	+3099.5	+823.4
V _{LCDOUT}	18	+3029.5	+823.4
V _{LCDOUT}	19	+2959.5	+823.4
V _{LCDOUT}	20	+2889.5	+823.4
V _{LCDOUT}	21	+2819.5	+823.4
V _{LCDOUT}	22	+2749.5	+823.4
V _{LCDOUT}	23	+2679.5	+823.4
V _{LCDIN}	24	+2539.5	+823.4
V _{LCDIN}	25	+2469.5	+823.4
V _{LCDIN}	26	+2399.5	+823.4
V _{LCDIN}	27	+2329.5	+823.4
V _{LCDIN}	28	+2259.5	+823.4
V _{LCDIN}	29	+2189.5	+823.4
V _{LCDIN}	30	+2119.5	+823.4
RES	31	+1979.5	+823.4
V_{DD3}	32	+1699.5	+823.4
V_{DD3}	33	+1629.5	+823.4
V_{DD3}	34	+1559.5	+823.4
V_{DD2}	35	+1279.5	+823.4
V_{DD2}	36	+1209.5	+823.4
V_{DD2}	37	+1139.5	+823.4

SYMBOL	PAD	x	у
V _{DD2}	38	+1069.5	+823.4
V _{DD2}	39	+999.5	+823.4
V_{DD2}	40	+929.5	+823.4
V_{DD2}	41	+859.5	+823.4
V _{DD2}	42	+789.5	+823.4
V _{DD1}	43	+649.5	+823.4
V_{DD1}	44	+579.5	+823.4
V _{DD1}	45	+509.5	+823.4
V_{DD1}	46	+439.5	+823.4
V _{DD1}	47	+369.5	+823.4
V _{DD1}	48	+299.5	+823.4
V _{DD1}	49	+229.5	+823.4
SDA	50	+19.5	+823.4
SDA	51	-50.5	+823.4
SDACK	52	-400.5	+823.4
dummy	53	-750.5	+823.4
SA0	54	-820.5	+823.4
ENR	55	-1100.5	+823.4
T4	56	-1380.5	+823.4
V _{SS2}	57	-1660.5	+823.4
V _{SS2}	58	-1730.5	+823.4
V _{SS2}	59	-1800.5	+823.4
V _{SS2}	60	-1870.5	+823.4
V _{SS2}	61	-1940.5	+823.4
V _{SS2}	62	-2010.5	+823.4
V _{SS2}	63	-2080.5	+823.4
V _{SS1}	64	-2220.5	+823.4
V _{SS1}	65	-2290.5	+823.4
V _{SS1}	66	-2360.5	+823.4
V _{SS1}	67	-2430.5	+823.4
V _{SS1}	68	-2500.5	+823.4
V _{SS1}	69	-2570.5	+823.4
V _{SS1}	70	-2640.5	+823.4
T3	71	-2780.5	+823.4
T1	72	-3060.5	+823.4
SCL	73	-3410.5	+823.4
SCL	74	-3480.5	+823.4
dummy	75	-3830.5	+823.4
dummy	76	-4180.5	+823.4
dummy	77	-4530.5	+823.4
T2	78	-4600.5	+823.4

34×128 pixel matrix driver

PCF8531

SYMBOL	PAD	x	у
dummy	79	-4880.5	+823.4
dummy	80	-4950.5	+823.4
dummy	81	-5230.5	+823.4
dummy	82	-5300.5	+823.4
dummy	83	-5650.5	+823.4
dummy	84	-5720.5	+823.4
dummy	85	-5930.5	+823.4
dummy	86	-5926.4	-821.7
R0	87	-5786.4	-821.7
R2	88	-5716.4	-821.7
R4	89	-5646.4	-821.7
R6	90	-5576.4	-821.7
R8	91	-5506.4	-821.7
R10	92	-5436.4	-821.7
R12	93	-5366.4	-821.7
R14	94	-5296.4	-821.7
R16	95	-5226.4	-821.7
R18	96	-5156.4	-821.7
R20	97	-5086.4	-821.7
R22	98	-5016.4	-821.7
R24	99	-4946.4	-821.7
R26	100	-4876.4	-821.7
R28	101	-4806.4	-821.7
R30	102	-4736.4	-821.7
R32	103	-4666.4	-821.7
C0	104	-4526.4	-821.7
C1	105	-4456.4	-821.7
C2	106	-4386.4	-821.7
C3	107	-4316.4	-821.7
C4	108	-4246.4	-821.7
C5	109	-4176.4	-821.7
C6	110	-4106.4	-821.7
C7	111	-4036.4	-821.7
C8	112	-3966.4	-821.7
C9	113	-3896.4	-821.7
C10	114	-3826.4	-821.7
C11	115	-3756.4	-821.7
C12	116	-3686.4	-821.7
C13	117	-3616.4	-821.7
C14	118	-3546.4	-821.7
C15	119	-3476.4	-821.7

SYMBOL PAD x y C16 120 -3406.4 -821.7 C17 121 -3336.4 -821.7 C18 122 -3266.4 -821.7 C19 123 -3196.4 -821.7 C20 124 -3126.4 -821.7 C21 125 -3056.4 -821.7 C22 126 -2986.4 -821.7 C23 127 -2916.4 -821.7 C24 128 -2846.4 -821.7 C25 129 -2776.4 -821.7 C26 130 -2706.4 -821.7 C26 130 -2706.4 -821.7 C28 132 -2566.4 -821.7 C29 133 -2496.4 -821.7 C30 134 -2426.4 -821.7 C31 135 -2356.4 -821.7 C31 135 -2356.4 -821.7 C33 137 -2146.4 </th <th>SYMBOL</th> <th>DAD</th> <th></th> <th>.,</th>	SYMBOL	DAD		.,
C17 121 -3336.4 -821.7 C18 122 -3266.4 -821.7 C19 123 -3196.4 -821.7 C20 124 -3126.4 -821.7 C21 125 -3056.4 -821.7 C22 126 -2986.4 -821.7 C22 126 -2986.4 -821.7 C23 127 -2916.4 -821.7 C24 128 -2846.4 -821.7 C25 129 -2776.4 -821.7 C26 130 -2706.4 -821.7 C26 130 -2766.4 -821.7 C28 132 -2566.4 -821.7 C30 134 -2426.4 -821.7 C31 135 -2356.4 -821.7 C32 136 -2216.4 -821.7 C33 137 -2146.4 -821.7 C33 137 -2146.4 -821.7 C34 138 -				
C18 122 -3266.4 -821.7 C19 123 -3196.4 -821.7 C20 124 -3126.4 -821.7 C21 125 -3056.4 -821.7 C22 126 -2986.4 -821.7 C23 127 -2916.4 -821.7 C24 128 -2846.4 -821.7 C25 129 -2776.4 -821.7 C26 130 -2706.4 -821.7 C26 130 -2706.4 -821.7 C27 131 -2636.4 -821.7 C28 132 -2566.4 -821.7 C30 134 -2426.4 -821.7 C31 135 -2356.4 -821.7 C32 136 -2216.4 -821.7 C33 137 -2146.4 -821.7 C34 138 -2076.4 -821.7 C35 139 -2006.4 -821.7 C36 140 -				
C19 123 -3196.4 -821.7 C20 124 -3126.4 -821.7 C21 125 -3056.4 -821.7 C22 126 -2986.4 -821.7 C23 127 -2916.4 -821.7 C24 128 -2846.4 -821.7 C25 129 -2776.4 -821.7 C26 130 -2706.4 -821.7 C27 131 -2636.4 -821.7 C28 132 -2566.4 -821.7 C29 133 -2496.4 -821.7 C30 134 -2426.4 -821.7 C31 135 -2356.4 -821.7 C31 135 -2356.4 -821.7 C33 137 -2146.4 -821.7 C34 138 -2076.4 -821.7 C35 139 -2006.4 -821.7 C36 140 -1936.4 -821.7 C37 141 -				
C20 124 -3126.4 -821.7 C21 125 -3056.4 -821.7 C22 126 -2986.4 -821.7 C23 127 -2916.4 -821.7 C24 128 -2846.4 -821.7 C25 129 -2776.4 -821.7 C26 130 -2706.4 -821.7 C26 130 -2766.4 -821.7 C28 132 -2566.4 -821.7 C29 133 -2496.4 -821.7 C30 134 -2426.4 -821.7 C31 135 -2356.4 -821.7 C31 135 -2356.4 -821.7 C32 136 -2216.4 -821.7 C33 137 -2146.4 -821.7 C34 138 -2076.4 -821.7 C35 139 -2006.4 -821.7 C36 140 -136.4 -821.7 C37 141 -1				
C21 125 -3056.4 -821.7 C22 126 -2986.4 -821.7 C23 127 -2916.4 -821.7 C24 128 -2846.4 -821.7 C25 129 -2776.4 -821.7 C26 130 -2706.4 -821.7 C27 131 -2636.4 -821.7 C28 132 -2566.4 -821.7 C29 133 -2496.4 -821.7 C30 134 -2426.4 -821.7 C31 135 -2356.4 -821.7 C32 136 -2216.4 -821.7 C33 137 -2146.4 -821.7 C34 138 -2076.4 -821.7 C35 139 -2006.4 -821.7 C36 140 -1936.4 -821.7 C37 141 -1866.4 -821.7 C39 143 -1726.4 -821.7 C40 144 -				
C22 126 -2986.4 -821.7 C23 127 -2916.4 -821.7 C24 128 -2846.4 -821.7 C25 129 -2776.4 -821.7 C26 130 -2706.4 -821.7 C27 131 -2636.4 -821.7 C28 132 -2566.4 -821.7 C29 133 -2496.4 -821.7 C30 134 -2426.4 -821.7 C30 134 -2426.4 -821.7 C31 135 -2356.4 -821.7 C32 136 -2216.4 -821.7 C33 137 -2146.4 -821.7 C34 138 -2076.4 -821.7 C35 139 -2006.4 -821.7 C36 140 -1936.4 -821.7 C37 141 -1866.4 -821.7 C39 143 -1726.4 -821.7 C40 144 -				
C23 127 -2916.4 -821.7 C24 128 -2846.4 -821.7 C25 129 -2776.4 -821.7 C26 130 -2706.4 -821.7 C27 131 -2636.4 -821.7 C28 132 -2566.4 -821.7 C29 133 -2496.4 -821.7 C30 134 -2426.4 -821.7 C31 135 -2356.4 -821.7 C31 135 -2356.4 -821.7 C32 136 -2216.4 -821.7 C33 137 -2146.4 -821.7 C34 138 -2076.4 -821.7 C35 139 -2006.4 -821.7 C36 140 -1936.4 -821.7 C37 141 -1866.4 -821.7 C38 142 -1796.4 -821.7 C40 144 -1656.4 -821.7 C41 145 -				
C24 128 -2846.4 -821.7 C25 129 -2776.4 -821.7 C26 130 -2706.4 -821.7 C27 131 -2636.4 -821.7 C28 132 -2566.4 -821.7 C29 133 -2496.4 -821.7 C30 134 -2426.4 -821.7 C31 135 -2356.4 -821.7 C31 135 -2356.4 -821.7 C32 136 -2216.4 -821.7 C33 137 -2146.4 -821.7 C34 138 -2076.4 -821.7 C35 139 -2006.4 -821.7 C36 140 -1936.4 -821.7 C37 141 -1866.4 -821.7 C38 142 -1796.4 -821.7 C39 143 -1726.4 -821.7 C40 144 -1656.4 -821.7 C41 145 -				
C25 129 -2776.4 -821.7 C26 130 -2706.4 -821.7 C27 131 -2636.4 -821.7 C28 132 -2566.4 -821.7 C29 133 -2496.4 -821.7 C30 134 -2426.4 -821.7 C31 135 -2356.4 -821.7 C32 136 -2216.4 -821.7 C33 137 -2146.4 -821.7 C33 137 -2146.4 -821.7 C34 138 -2076.4 -821.7 C35 139 -2006.4 -821.7 C36 140 -1936.4 -821.7 C37 141 -1866.4 -821.7 C38 142 -1796.4 -821.7 C39 143 -1726.4 -821.7 C40 144 -1656.4 -821.7 C41 145 -1586.4 -821.7 C42 146 -				
C26 130 -2706.4 -821.7 C27 131 -2636.4 -821.7 C28 132 -2566.4 -821.7 C29 133 -2496.4 -821.7 C30 134 -2426.4 -821.7 C31 135 -2356.4 -821.7 C32 136 -2216.4 -821.7 C33 137 -2146.4 -821.7 C34 138 -2076.4 -821.7 C34 138 -2076.4 -821.7 C35 139 -2006.4 -821.7 C36 140 -1936.4 -821.7 C37 141 -1866.4 -821.7 C38 142 -1796.4 -821.7 C39 143 -1726.4 -821.7 C40 144 -1656.4 -821.7 C41 145 -1586.4 -821.7 C42 146 -1516.4 -821.7 C43 147 -	C24	128		
C27 131 -2636.4 -821.7 C28 132 -2566.4 -821.7 C29 133 -2496.4 -821.7 C30 134 -2426.4 -821.7 C31 135 -2356.4 -821.7 C32 136 -2216.4 -821.7 C33 137 -2146.4 -821.7 C34 138 -2076.4 -821.7 C35 139 -2006.4 -821.7 C35 139 -2006.4 -821.7 C36 140 -1936.4 -821.7 C37 141 -1866.4 -821.7 C38 142 -1796.4 -821.7 C39 143 -1726.4 -821.7 C40 144 -1656.4 -821.7 C41 145 -1586.4 -821.7 C42 146 -1516.4 -821.7 C43 147 -1446.4 -821.7 C45 149 -		129		
C28 132 -2566.4 -821.7 C29 133 -2496.4 -821.7 C30 134 -2426.4 -821.7 C31 135 -2356.4 -821.7 C32 136 -2216.4 -821.7 C33 137 -2146.4 -821.7 C34 138 -2076.4 -821.7 C35 139 -2006.4 -821.7 C36 140 -1936.4 -821.7 C37 141 -1866.4 -821.7 C38 142 -1796.4 -821.7 C39 143 -1726.4 -821.7 C40 144 -1656.4 -821.7 C41 145 -1586.4 -821.7 C42 146 -1516.4 -821.7 C43 147 -1446.4 -821.7 C44 148 -1376.4 -821.7 C45 149 -1306.4 -821.7 C46 150 -	C26	130	-2706.4	-821.7
C29 133 -2496.4 -821.7 C30 134 -2426.4 -821.7 C31 135 -2356.4 -821.7 C32 136 -2216.4 -821.7 C33 137 -2146.4 -821.7 C34 138 -2076.4 -821.7 C35 139 -2006.4 -821.7 C36 140 -1936.4 -821.7 C37 141 -1866.4 -821.7 C38 142 -1796.4 -821.7 C39 143 -1726.4 -821.7 C40 144 -1656.4 -821.7 C41 145 -1586.4 -821.7 C42 146 -1516.4 -821.7 C43 147 -1446.4 -821.7 C44 148 -1376.4 -821.7 C45 149 -1306.4 -821.7 C46 150 -1236.4 -821.7 C48 152 -		131	-2636.4	-821.7
C30 134 -2426.4 -821.7 C31 135 -2356.4 -821.7 C32 136 -2216.4 -821.7 C33 137 -2146.4 -821.7 C34 138 -2076.4 -821.7 C35 139 -2006.4 -821.7 C36 140 -1936.4 -821.7 C37 141 -1866.4 -821.7 C38 142 -1796.4 -821.7 C39 143 -1726.4 -821.7 C40 144 -1656.4 -821.7 C41 145 -1586.4 -821.7 C42 146 -1516.4 -821.7 C43 147 -1446.4 -821.7 C44 148 -1376.4 -821.7 C45 149 -1306.4 -821.7 C46 150 -1236.4 -821.7 C48 152 -1096.4 -821.7 C49 153 -	C28	132	-2566.4	-821.7
C31 135 -2356.4 -821.7 C32 136 -2216.4 -821.7 C33 137 -2146.4 -821.7 C34 138 -2076.4 -821.7 C35 139 -2006.4 -821.7 C36 140 -1936.4 -821.7 C37 141 -1866.4 -821.7 C38 142 -1796.4 -821.7 C39 143 -1726.4 -821.7 C40 144 -1656.4 -821.7 C41 145 -1586.4 -821.7 C42 146 -1516.4 -821.7 C43 147 -1446.4 -821.7 C44 148 -1376.4 -821.7 C45 149 -1306.4 -821.7 C46 150 -1236.4 -821.7 C47 151 -1166.4 -821.7 C49 153 -1026.4 -821.7 C50 154 -	C29	133	-2496.4	-821.7
C32 136 -2216.4 -821.7 C33 137 -2146.4 -821.7 C34 138 -2076.4 -821.7 C35 139 -2006.4 -821.7 C36 140 -1936.4 -821.7 C37 141 -1866.4 -821.7 C38 142 -1796.4 -821.7 C39 143 -1726.4 -821.7 C40 144 -1656.4 -821.7 C41 145 -1586.4 -821.7 C42 146 -1516.4 -821.7 C43 147 -1446.4 -821.7 C44 148 -1376.4 -821.7 C45 149 -1306.4 -821.7 C46 150 -1236.4 -821.7 C47 151 -1166.4 -821.7 C49 153 -1026.4 -821.7 C50 154 -956.4 -821.7 C51 155 -8	C30	134	-2426.4	-821.7
C33 137 -2146.4 -821.7 C34 138 -2076.4 -821.7 C35 139 -2006.4 -821.7 C36 140 -1936.4 -821.7 C37 141 -1866.4 -821.7 C38 142 -1796.4 -821.7 C39 143 -1726.4 -821.7 C40 144 -1656.4 -821.7 C41 145 -1586.4 -821.7 C41 145 -1586.4 -821.7 C42 146 -1516.4 -821.7 C43 147 -1446.4 -821.7 C44 148 -1376.4 -821.7 C45 149 -1306.4 -821.7 C46 150 -1236.4 -821.7 C47 151 -1166.4 -821.7 C48 152 -1096.4 -821.7 C50 154 -956.4 -821.7 C51 155 -8	C31	135	-2356.4	-821.7
C34 138 -2076.4 -821.7 C35 139 -2006.4 -821.7 C36 140 -1936.4 -821.7 C37 141 -1866.4 -821.7 C38 142 -1796.4 -821.7 C39 143 -1726.4 -821.7 C40 144 -1656.4 -821.7 C41 145 -1586.4 -821.7 C42 146 -1516.4 -821.7 C43 147 -1446.4 -821.7 C43 147 -1446.4 -821.7 C44 148 -1376.4 -821.7 C45 149 -1306.4 -821.7 C46 150 -1236.4 -821.7 C48 152 -1096.4 -821.7 C49 153 -1026.4 -821.7 C50 154 -956.4 -821.7 C51 155 -886.4 -821.7 C52 156 -81	C32	136	-2216.4	-821.7
C35 139 -2006.4 -821.7 C36 140 -1936.4 -821.7 C37 141 -1866.4 -821.7 C38 142 -1796.4 -821.7 C39 143 -1726.4 -821.7 C40 144 -1656.4 -821.7 C41 145 -1586.4 -821.7 C42 146 -1516.4 -821.7 C43 147 -1446.4 -821.7 C43 147 -1446.4 -821.7 C44 148 -1376.4 -821.7 C45 149 -1306.4 -821.7 C46 150 -1236.4 -821.7 C47 151 -1166.4 -821.7 C48 152 -1096.4 -821.7 C49 153 -1026.4 -821.7 C50 154 -956.4 -821.7 C51 155 -886.4 -821.7 C52 156 -81	C33	137	-2146.4	-821.7
C36 140 -1936.4 -821.7 C37 141 -1866.4 -821.7 C38 142 -1796.4 -821.7 C39 143 -1726.4 -821.7 C40 144 -1656.4 -821.7 C41 145 -1586.4 -821.7 C42 146 -1516.4 -821.7 C43 147 -1446.4 -821.7 C43 147 -1446.4 -821.7 C44 148 -1376.4 -821.7 C45 149 -1306.4 -821.7 C46 150 -1236.4 -821.7 C47 151 -1166.4 -821.7 C48 152 -1096.4 -821.7 C49 153 -1026.4 -821.7 C51 155 -886.4 -821.7 C51 155 -886.4 -821.7 C52 156 -816.4 -821.7 C53 157 -746	C34	138	-2076.4	-821.7
C37 141 -1866.4 -821.7 C38 142 -1796.4 -821.7 C39 143 -1726.4 -821.7 C40 144 -1656.4 -821.7 C41 145 -1586.4 -821.7 C42 146 -1516.4 -821.7 C43 147 -1446.4 -821.7 C43 148 -1376.4 -821.7 C44 148 -1376.4 -821.7 C45 149 -1306.4 -821.7 C47 151 -1166.4 -821.7 C48 152 -1096.4 -821.7 C49 153 -1026.4 -821.7 C50 154 -956.4 -821.7 C51 155 -886.4 -821.7 C52 156 -816.4 -821.7 C53 157 -746.4 -821.7 C54 158 -676.4 -821.7 C55 159 -606.4	C35	139	-2006.4	-821.7
C38 142 -1796.4 -821.7 C39 143 -1726.4 -821.7 C40 144 -1656.4 -821.7 C41 145 -1586.4 -821.7 C42 146 -1516.4 -821.7 C43 147 -1446.4 -821.7 C44 148 -1376.4 -821.7 C45 149 -1306.4 -821.7 C46 150 -1236.4 -821.7 C47 151 -1166.4 -821.7 C48 152 -1096.4 -821.7 C49 153 -1026.4 -821.7 C50 154 -956.4 -821.7 C51 155 -886.4 -821.7 C52 156 -816.4 -821.7 C53 157 -746.4 -821.7 C54 158 -676.4 -821.7 C55 159 -606.4 -821.7	C36	140	-1936.4	-821.7
C39 143 -1726.4 -821.7 C40 144 -1656.4 -821.7 C41 145 -1586.4 -821.7 C42 146 -1516.4 -821.7 C43 147 -1446.4 -821.7 C44 148 -1376.4 -821.7 C45 149 -1306.4 -821.7 C46 150 -1236.4 -821.7 C47 151 -1166.4 -821.7 C48 152 -1096.4 -821.7 C49 153 -1026.4 -821.7 C50 154 -956.4 -821.7 C51 155 -886.4 -821.7 C52 156 -816.4 -821.7 C53 157 -746.4 -821.7 C54 158 -676.4 -821.7 C55 159 -606.4 -821.7	C37	141	-1866.4	-821.7
C40 144 -1656.4 -821.7 C41 145 -1586.4 -821.7 C42 146 -1516.4 -821.7 C43 147 -1446.4 -821.7 C44 148 -1376.4 -821.7 C45 149 -1306.4 -821.7 C46 150 -1236.4 -821.7 C47 151 -1166.4 -821.7 C48 152 -1096.4 -821.7 C49 153 -1026.4 -821.7 C50 154 -956.4 -821.7 C51 155 -886.4 -821.7 C52 156 -816.4 -821.7 C53 157 -746.4 -821.7 C54 158 -676.4 -821.7 C55 159 -606.4 -821.7	C38	142	-1796.4	-821.7
C41 145 -1586.4 -821.7 C42 146 -1516.4 -821.7 C43 147 -1446.4 -821.7 C44 148 -1376.4 -821.7 C45 149 -1306.4 -821.7 C46 150 -1236.4 -821.7 C47 151 -1166.4 -821.7 C48 152 -1096.4 -821.7 C49 153 -1026.4 -821.7 C50 154 -956.4 -821.7 C51 155 -886.4 -821.7 C52 156 -816.4 -821.7 C53 157 -746.4 -821.7 C54 158 -676.4 -821.7 C55 159 -606.4 -821.7	C39	143	-1726.4	-821.7
C42 146 -1516.4 -821.7 C43 147 -1446.4 -821.7 C44 148 -1376.4 -821.7 C45 149 -1306.4 -821.7 C46 150 -1236.4 -821.7 C47 151 -1166.4 -821.7 C48 152 -1096.4 -821.7 C49 153 -1026.4 -821.7 C50 154 -956.4 -821.7 C51 155 -886.4 -821.7 C52 156 -816.4 -821.7 C53 157 -746.4 -821.7 C54 158 -676.4 -821.7 C55 159 -606.4 -821.7	C40	144	-1656.4	-821.7
C43 147 -1446.4 -821.7 C44 148 -1376.4 -821.7 C45 149 -1306.4 -821.7 C46 150 -1236.4 -821.7 C47 151 -1166.4 -821.7 C48 152 -1096.4 -821.7 C49 153 -1026.4 -821.7 C50 154 -956.4 -821.7 C51 155 -886.4 -821.7 C52 156 -816.4 -821.7 C53 157 -746.4 -821.7 C54 158 -676.4 -821.7 C55 159 -606.4 -821.7	C41	145	-1586.4	-821.7
C44 148 -1376.4 -821.7 C45 149 -1306.4 -821.7 C46 150 -1236.4 -821.7 C47 151 -1166.4 -821.7 C48 152 -1096.4 -821.7 C49 153 -1026.4 -821.7 C50 154 -956.4 -821.7 C51 155 -886.4 -821.7 C52 156 -816.4 -821.7 C53 157 -746.4 -821.7 C54 158 -676.4 -821.7 C55 159 -606.4 -821.7	C42	146	-1516.4	-821.7
C45 149 -1306.4 -821.7 C46 150 -1236.4 -821.7 C47 151 -1166.4 -821.7 C48 152 -1096.4 -821.7 C49 153 -1026.4 -821.7 C50 154 -956.4 -821.7 C51 155 -886.4 -821.7 C52 156 -816.4 -821.7 C53 157 -746.4 -821.7 C54 158 -676.4 -821.7 C55 159 -606.4 -821.7	C43	147	-1446.4	-821.7
C45 149 -1306.4 -821.7 C46 150 -1236.4 -821.7 C47 151 -1166.4 -821.7 C48 152 -1096.4 -821.7 C49 153 -1026.4 -821.7 C50 154 -956.4 -821.7 C51 155 -886.4 -821.7 C52 156 -816.4 -821.7 C53 157 -746.4 -821.7 C54 158 -676.4 -821.7 C55 159 -606.4 -821.7	C44	148	-1376.4	-821.7
C47 151 -1166.4 -821.7 C48 152 -1096.4 -821.7 C49 153 -1026.4 -821.7 C50 154 -956.4 -821.7 C51 155 -886.4 -821.7 C52 156 -816.4 -821.7 C53 157 -746.4 -821.7 C54 158 -676.4 -821.7 C55 159 -606.4 -821.7	C45	149	-1306.4	-821.7
C48 152 -1096.4 -821.7 C49 153 -1026.4 -821.7 C50 154 -956.4 -821.7 C51 155 -886.4 -821.7 C52 156 -816.4 -821.7 C53 157 -746.4 -821.7 C54 158 -676.4 -821.7 C55 159 -606.4 -821.7	C46	150	-1236.4	-821.7
C49 153 -1026.4 -821.7 C50 154 -956.4 -821.7 C51 155 -886.4 -821.7 C52 156 -816.4 -821.7 C53 157 -746.4 -821.7 C54 158 -676.4 -821.7 C55 159 -606.4 -821.7	C47	151	-1166.4	-821.7
C50 154 -956.4 -821.7 C51 155 -886.4 -821.7 C52 156 -816.4 -821.7 C53 157 -746.4 -821.7 C54 158 -676.4 -821.7 C55 159 -606.4 -821.7	C48	152	-1096.4	-821.7
C51 155 -886.4 -821.7 C52 156 -816.4 -821.7 C53 157 -746.4 -821.7 C54 158 -676.4 -821.7 C55 159 -606.4 -821.7	C49	153	-1026.4	-821.7
C52 156 -816.4 -821.7 C53 157 -746.4 -821.7 C54 158 -676.4 -821.7 C55 159 -606.4 -821.7	C50	154	-956.4	-821.7
C52 156 -816.4 -821.7 C53 157 -746.4 -821.7 C54 158 -676.4 -821.7 C55 159 -606.4 -821.7	C51	155	-886.4	-821.7
C53 157 -746.4 -821.7 C54 158 -676.4 -821.7 C55 159 -606.4 -821.7	C52	156	-816.4	
C54 158 -676.4 -821.7 C55 159 -606.4 -821.7				
C55 159 -606.4 -821.7	C54	158	-676.4	

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SYMBOL	PAD	х	у
C57	161	-466.4	-821.7
C58	162	-396.4	-821.7
C59	163	-326.4	-821.7
C60	164	-256.4	-821.7
C61	165	-186.4	-821.7
C62	166	-116.4	-821.7
C63	167	-46.4	-821.7
C64	168	+93.6	-821.7
C65	169	+163.6	-821.7
C66	170	+233.6	-821.7
C67	171	+303.6	-821.7
C68	172	+373.6	-821.7
C69	173	+443.6	-821.7
C70	174	+513.6	-821.7
C71	175	+583.6	-821.7
C72	176	+653.6	-821.7
C73	177	+723.6	-821.7
C74	178	+793.6	-821.7
C75	179	+863.6	-821.7
C76	180	+933.6	-821.7
C77	181	+1003.6	-821.7
C78	182	+1073.6	-821.7
C79	183	+1143.6	-821.7
C80	184	+1213.6	-821.7
C81	185	+1283.6	-821.7
C82	186	+1353.6	-821.7
C83	187	+1423.6	-821.7
C84	188	+1493.6	-821.7
C85	189	+1563.6	-821.7
C86	190	+1633.6	-821.7
C87	191	+1703.6	-821.7
C88	192	+1773.6	-821.7
C89	193	+1843.6	-821.7
C90	194	+1913.6	-821.7
C91	195	+1983.6	-821.7
C92	196	+2053.6	-821.7
C93	197	+2123.6	-821.7
C94	198	+2193.6	-821.7
C95	199	+2263.6	-821.7
C96	200	+2403.6	-821.7
C97	201	+2473.6	-821.7

SYMBOL	PAD	x	у
C98	202	+2543.6	_821.7
C99	203	+2613.6	-821.7
C100	204	+2683.6	-821.7
C101	205	+2753.6	-821.7
C102	206	+2823.6	-821.7
C102	207	+2893.6	-821.7
C103	208	+2093.0	-821.7
C104	200	+3033.6	-821.7 -821.7
C105	210	+3103.6	-821.7 -821.7
C100	210	+3173.6	-821.7 -821.7
_			-821.7 -821.7
C108	212 213	+3243.6	-821.7 -821.7
C109 C110	213	+3313.6	-821.7 -821.7
		+3383.6	_
C111	215	+3453.6	-821.7
C112	216	+3523.6	-821.7
C113	217	+3593.6	-821.7
C114	218	+3663.6	-821.7
C115	219	+3733.6	-821.7
C116	220	+3803.6	-821.7
C117	221	+3873.6	-821.7
C118	222	+3943.6	-821.7
C119	223	+4013.6	-821.7
C120	224	+4083.6	-821.7
C121	225	+4153.6	-821.7
C122	226	+4223.6	-821.7
C123	227	+4293.6	-821.7
C124	228	+4363.6	-821.7
C125	229	+4433.6	-821.7
C126	230	+4503.6	-821.7
C127	231	+4573.6	-821.7
R33	232	+4713.6	-821.7
R31	233	+4783.6	-821.7
R29	234	+4853.6	-821.7
R27	235	+4923.6	-821.7
R25	236	+4993.6	-821.7
R23	237	+5063.6	-821.7
R21	238	+5133.6	-821.7
R19	239	+5203.6	-821.7
R17	240	+5343.6	-821.7
R15	241	+5413.6	-821.7
R13	242	+5483.6	-821.7

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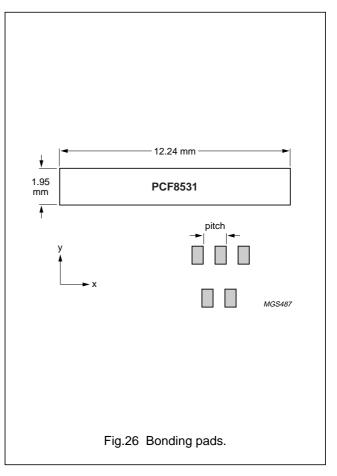
SYMBOL	PAD	х	у
R11	243	+5553.6	-821.7
R9	244	+5623.6	-821.7
R7	245	+5693.6	-821.7
R5	246	+5763.6	-821.7
R3	247	+5833.6	-821.7
R1	248	+5903.6	-821.7

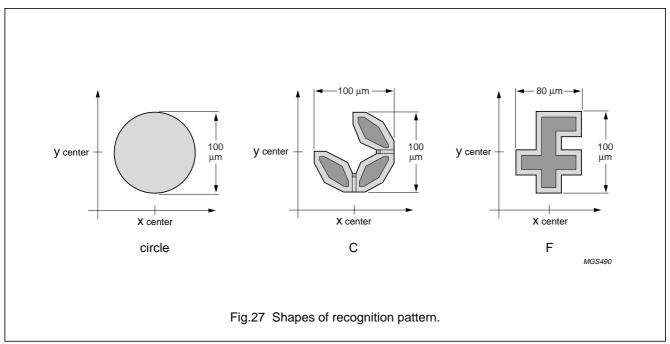
Table 11 Bonding pads

PAD	SIZE	UNIT
Pad pitch	min. 70	μm
Pad size; Al	62 × 100	μm
Bump dimensions	50 × 90 × 17.5 (±5)	μm
Wafer thickness (excluding bumps)	381	μm

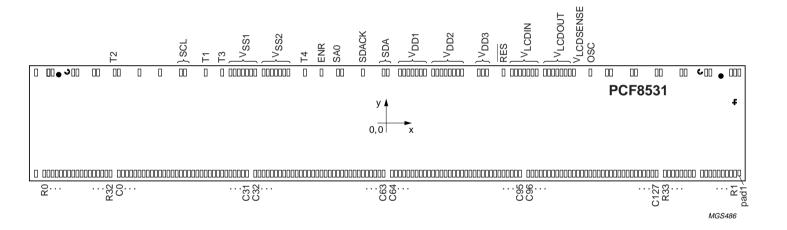
Table 12 Alignment marks

MARKS	х	у
C1	-5402.0	+823.1
C2	+5292.4	+823.4
F	+5890.3	+401.9
Circle 1	-5543.0	+798.4
Circle 2	+5637.4	+798.4





Product specification



The positioning of the bonding pads is not to scale.

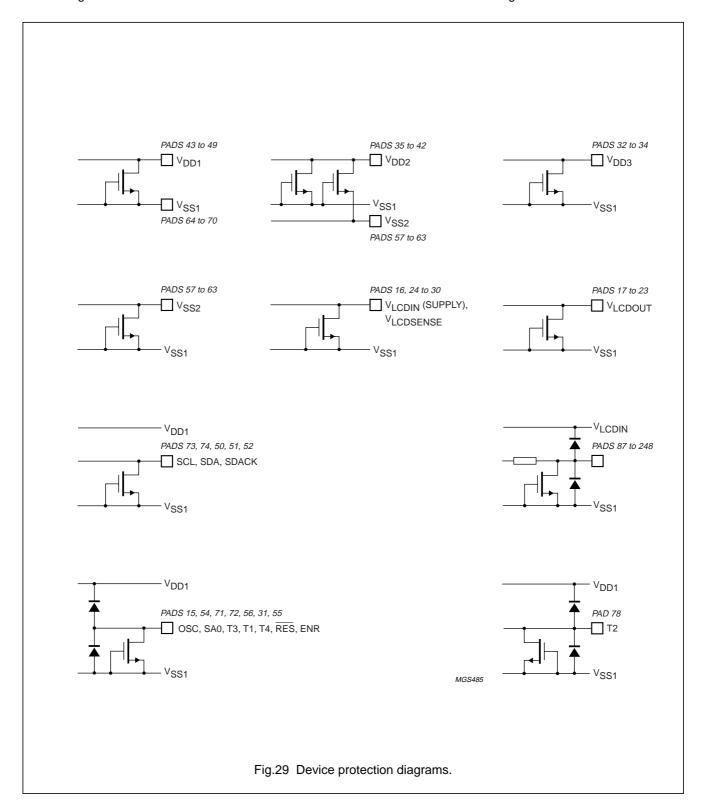
Fig.28 Bonding pad location.

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16 DEVICE PROTECTION DIAGRAM

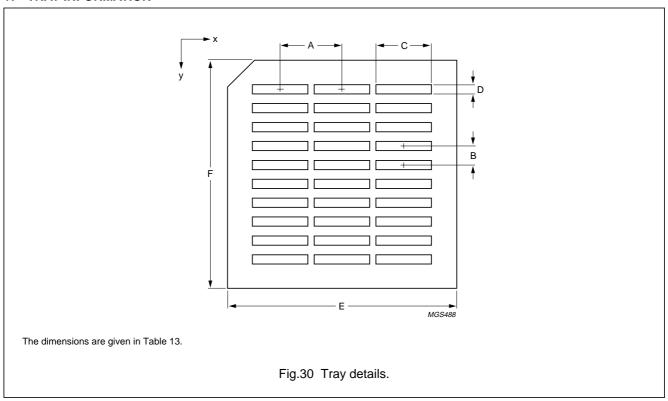
For all diagrams: the maximum forward current is 5 mA and the maximum reverse voltage is 5 V.



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17 TRAY INFORMATION



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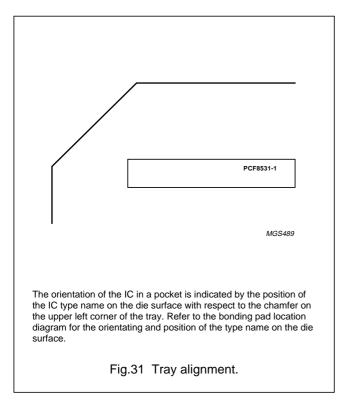


Table 13 Dimensions

DIM.	DESCRIPTION	VALUE
Α	pocket pitch; x direction	13.72 mm
В	pocket pitch; y direction	4.17 mm
С	pocket width; x direction	12.34 mm
D	pocket width; y direction	2.05 mm
Е	tray width; x direction	50.8 mm
F	tray width; y direction	50.8 mm
Х	number of pockets in x direction	3
у	number of pockets in y direction	10

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18 DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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NOTES

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NOTES

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